



**THE DATASHEET OF  
9P935AFLFT**



# DDR I/DDR II Phase Lock Loop Zero Delay Buffer

ICS9P935

## Description

DDR I/DDR II Zero Delay Clock Buffer

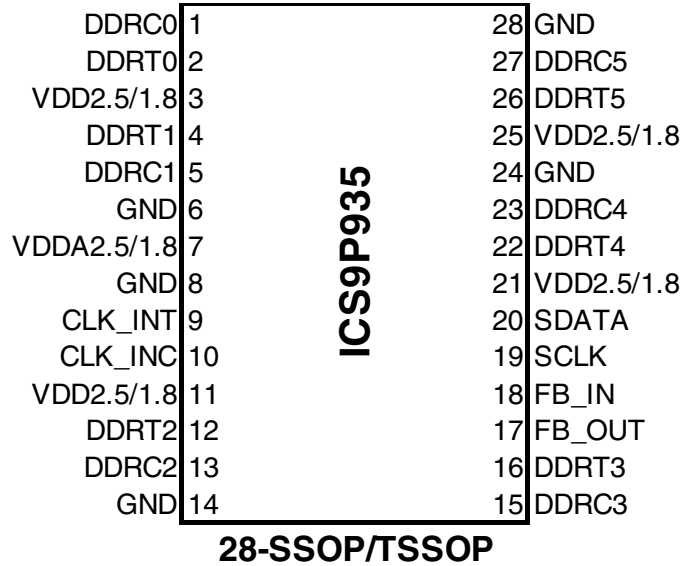
## Output Features

- Low skew, low jitter PLL clock driver
- Max frequency supported = 400MHz (DDR II 800)
- I<sup>2</sup>C for functional and output control
- Feedback pins for input to output synchronization
- Spread Spectrum tolerant inputs
- Programmable skew through SMBus
- Frequency defect control through SMBus
- Individual output control programmable through SMBus

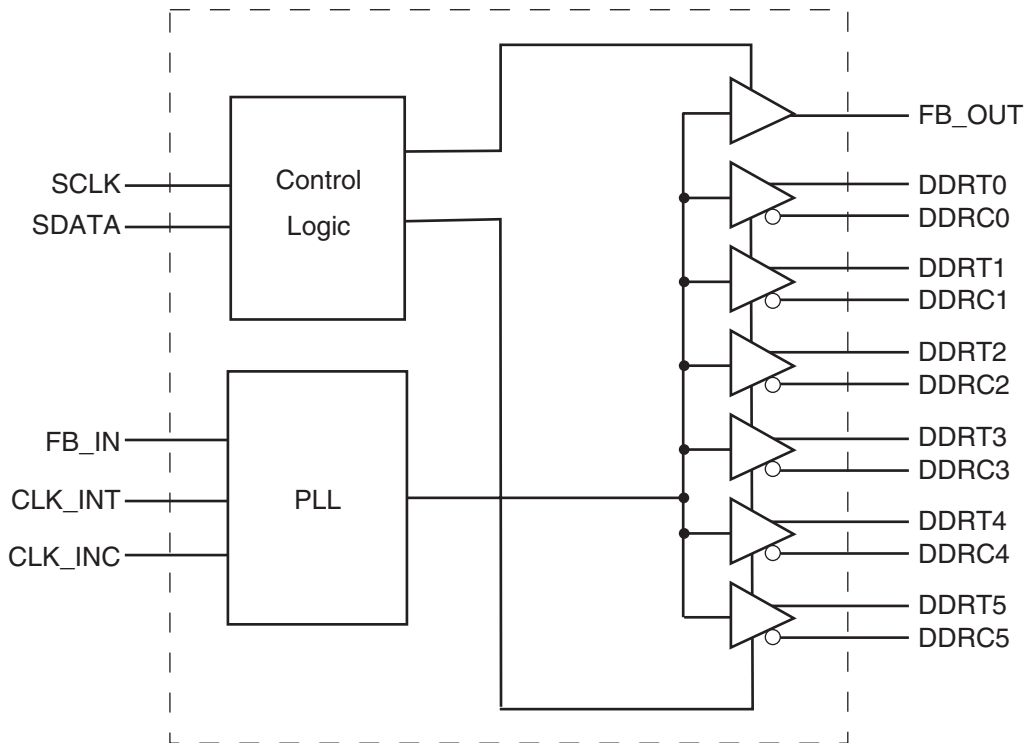
## Key Specifications

- CYCLE - CYCLE jitter: <100ps
- OUTPUT - OUTPUT skew: <100ps
- DUTY CYCLE: 48% - 52%
- 28-pin SSOP package
- Available in RoHS compliant packaging
- Operates @ 2.5V or 1.8V

## Pin Configuration



## Functional Block Diagram



## Pin Description

Pin#	Pin Name	Type	Pin Description
1	DDRC0	OUT	"Complementary" Clock of differential pair output.
2	DDRT0	OUT	"True" Clock of differential pair output.
3	VDD2.5/1.8	PWR	Power supply, nominal 2.5V or 1.8V
4	DDRT1	OUT	"True" Clock of differential pair output.
5	DDRC1	OUT	"Complementary" Clock of differential pair output.
6	GND	PWR	Ground pin.
7	VDDA2.5/1.8	PWR	Output power supply, nominal 2.5V or 1.8V
8	GND	PWR	Ground pin.
9	CLK_INT	IN	"True" reference clock input.
10	CLK_INC	IN	"Complementary" reference clock input.
11	VDD2.5/1.8	PWR	Power supply, nominal 2.5V or 1.8V
12	DDRT2	OUT	"True" Clock of differential pair output.
13	DDRC2	OUT	"Complementary" Clock of differential pair output.
14	GND	PWR	Ground pin.
15	DDRC3	OUT	"Complementary" Clock of differential pair output.
16	DDRT3	OUT	"True" Clock of differential pair output.
17	FB_OUT	OUT	Feedback output, dedicated for external feedback.
18	FB_IN	IN	Single-ended feedback input, provides feedback signal to internal PLL to eliminate phase error with the input clock.
19	SCLK	IN	Clock pin of SMBus circuitry, 3.3V tolerant.
20	SDATA	I/O	Data pin for SMBus circuitry, 3.3V tolerant.
21	VDD2.5/1.8	PWR	Power supply, nominal 2.5V or 1.8V
22	DDRT4	OUT	"True" Clock of differential pair output.
23	DDRC4	OUT	"Complementary" Clock of differential pair output.
24	GND	PWR	Ground pin.
25	VDD2.5/1.8	PWR	Power supply, nominal 2.5V or 1.8V
26	DDRT5	OUT	"True" Clock of differential pair output.
27	DDRC5	OUT	"Complementary" Clock of differential pair output.
28	GND	PWR	Ground pin.

## Absolute Max

Supply Voltage	-0.5V to 2.7V
Logic Inputs	GND -0.5 V to $V_{DD} + 0.5 V$
Ambient Operating Temperature	0°C to +70°C
Case Temperature	115°C
Storage Temperature	-65°C to +150°C

Stresses above those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only and functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

## Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage AVDD, VDD = 1.8 V +/- 0.1V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Current	$I_{IH}$	$V_I = V_{DD}$ or GND			±250	μA
Input Low Current	$I_{IL}$	$V_I = V_{DD}$ or GND			±10	μA
Output Disabled Low Current	$I_{ODL}$	OE = L, $V_{ODL} = 100\text{mV}$	100			μA
Operating Supply Current	$I_{DD1.8}$	$C_L = 0\text{pf}$ @ 100MHz			300	mA
	$I_{DDL D}$	$C_L = 0\text{pf}$			500	μA
Input Clamp Voltage	$V_{IK}$	$V_{DDQ} = 1.8\text{V}$ $I_{in} = -18\text{mA}$			-1.2	V
High-level output voltage	$V_{OH}$	$I_{OH} = -100\mu\text{A}$	$V_{DD} - 0.2$			V
		$I_{OH} = -9\text{mA}$	1.1			V
Low-level output voltage	$V_{OL}$	$I_{OL} = 100\mu\text{A}$			0.1	V
		$I_{OL} = 9\text{mA}$			0.6	V
Input Capacitance <sup>1</sup>	$C_{IN}$	$V_I = \text{GND}$ or $V_{DD}$	2		3	pF
Output Capacitance <sup>1</sup>	$C_{OUT}$	$V_{OUT} = \text{GND}$ or $V_{DD}$	2		3	pF

### Recommended Operating Condition (see note1)

$T_A = 0 - 70^{\circ}\text{C}$ ; Supply Voltage AVDD, VDD = 1.8 V +/- 0.1V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	$V_{DDQ}, A_{VDD}$		1.7	1.8	1.9	V
Low level input voltage	$V_{IL}$	CLK_INT, CLK_INC, FB_IN			$0.35 \times V_{DD}$	V
High level input voltage	$V_{IH}$	CLK_INT, CLK_INC, FB_IN	$0.65 \times V_{DD}$			V
DC input signal voltage (note 2)	$V_{IN}$		-0.3		$V_{DD} + 0.3$	V
DC input signal voltage swing	$V_{IN-Diff}$	CLK_INT, CLK_INC	GND - 0.3	1.5	$V_{DD} + 0.3$	V
Differential input signal voltage (note 3)	$V_{ID}$	DC - CLK_INT, CLK_INC, FB_IN	0.3		$V_{DD} + 0.4$	V
		AC - CLK_INT, CLK_INC, FB_IN	0.6		$V_{DD} + 0.4$	V
Output differential cross-voltage (note 4)	$V_{OX}$		$V_{DD} / 2 - 0.1$		$V_{DD} / 2 + 0.1$	V
Input differential cross-voltage (note 4)	$V_{IX}$		$V_{DD}/2 - 0.15$	$V_{DD}/2$	$V_{DD} / 2 + 0.15$	V
High level output current	$I_{OH}$				-9	mA
Low level output current	$I_{OL}$				9	mA
High Impedance Output Current	$I_{OZ}$	$V_{DD}=1.9V, V_{OUT}=V_{DD}$ or GND			$\pm 10$	mA
Operating free-air temperature	$T_A$		0		70	$^{\circ}\text{C}$

**Notes:**

1. Unused inputs must be held high or low to prevent them from floating.
2. DC input signal voltage specifies the allowable DC execution of differential input.
3. Differential inputs signal voltages specifies the differential voltage [VTR-VCP] required for switching, where VTR is the true input level and VCP is the complementary input level.
4. Differential cross-point voltage is expected to track variations of  $V_{DD}$  and is the voltage at which the differential signal must be crossing.

## Timing Requirements

$T_A = 0 - 70^\circ\text{C}$  Supply Voltage AVDD, VDD = 1.8 V +/- 0.1V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS
Max clock frequency	freq <sub>op</sub>	1.8V±0.1V @ 25°C	125	500	MHz
Application Frequency Range	freq <sub>App</sub>	1.8V±0.1V @ 25°C	160	400	MHz
Input clock duty cycle	d <sub>tin</sub>		40	60	%
CLK stabilization	T <sub>STAB</sub>			15	µs

## Switching Characteristics<sup>1</sup>

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Output enable time	t <sub>en</sub>	OE to any output			8	ns
Output disable time	t <sub>dis</sub>	OE to any output			8	ns
Period jitter	t <sub>jit(per)</sub>		-40		40	ps
Half-period jitter	t <sub>jit(hper)</sub>		-75		75	ps
Input slew rate	SLr1(i)	Input Clock	1	2.5	4	v/ns
		Output Enable (OE), (OS)	0.5			v/ns
Output clock slew rate	SLr1(o)		1.5	2.5	3	v/ns
Cycle-to-cycle period jitter	t <sub>jit(cc+)</sub>		0		40	ps
	t <sub>jit(cc-)</sub>		0		-40	ps
Dynamic Phase Offset	t <sub>( )dyn</sub>		-50		50	ps
Phase error	t <sub>(phase error)</sub> <sup>2</sup>		-50	0	50	ps
Output to Output Skew	t <sub>skew</sub>				40	ps
SSC modulation frequency			30.00		33	kHz
SSC clock input frequency deviation			0.00		-0.50	%

### Notes:

1. Refers to transition on noninverting output in PLL bypass mode.
2. While the pulse skew is almost constant over frequency, the duty cycle error increases at higher frequencies. This is due to the formula: duty cycle=t<sub>WH</sub>/t<sub>c</sub>, were the cycle (t<sub>c</sub>) decreases as the frequency goes up.
3. Switching characteristics guaranteed for application frequency range.
4. Static phase offset shifted by design.

### Electrical Characteristics - Input/Supply/Common Output Parameters

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $A_{V_{DD}}$ ,  $V_{DD} = 2.5\text{V} \pm 0.2\text{V}$

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Input High Current	$I_{IH}$	$V_I = V_{DD}$ or GND	5			$\mu\text{A}$
Input Low Current	$I_{IL}$	$V_I = V_{DD}$ or GND			5	$\mu\text{A}$
Operating Supply Current	$I_{DD2.5}$	$C_L = 0\text{pf}$ @ 200MHz		250		mA
	$I_{DDPD}$	$C_L = 0\text{pf}$			100	$\mu\text{A}$
Output High Current	$I_{OH}$	$V_{DD} = 2.3\text{V}$ , $V_{OUT} = 1\text{V}$	-18	-32		mA
Output Low Current	$I_{OL}$	$V_{DD} = 2.3\text{V}$ , $V_{OUT} = 1.2\text{V}$	26	35		mA
High Impedance Output Current	$I_{OZ}$	$V_{DD}=2.7\text{V}$ , $V_{out}=V_{DD}$ or GND			$\pm 10$	mA
Input Clamp Voltage	$V_{IK}$	$V_{DDQ} = 2.3\text{V}$ $I_{in} = -18\text{mA}$			-1.2	V
High-level output voltage	$V_{OH}$	$V_{DD} = \text{min to max}$ , $I_{OH} = -1 \text{ mA}$	$V_{DDQ} - 0.1$			V
		$V_{DDQ} = 2.3\text{V}$ , $I_{OH} = -12 \text{ mA}$	1.7			V
Low-level output voltage	$V_{OL}$	$V_{DD} = \text{min to max}$ $I_{OL}=1 \text{ mA}$			0.1	V
		$V_{DDQ} = 2.3\text{V}$ $I_{OH}=12 \text{ mA}$			0.6	V
Input Capacitance <sup>1</sup>	$C_{IN}$	$V_I = \text{GND}$ or $V_{DD}$		3		pF
Output Capacitance <sup>1</sup>	$C_{OUT}$	$V_{OUT} = \text{GND}$ or $V_{DD}$		3		pF

## Recommended Operating Condition (see note 1)

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage AVDD, VDD = 2.5 V +/- 0.2V (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage	$V_{DD}, A_{VDD}$		2.3	2.5	2.7	V
Low level input voltage	$V_{IL}$	DDRT,DDRC		0.4	$V_{DD}/2 - 0.18$	V
High level input voltage	$V_{IH}$	DDRT,DDRC	$V_{DD}/2 + 0.18$	2.1		V
DC input signal voltage (note 2)	$V_{IN}$		-0.3		$V_{DD} + 0.3$	V
Differential input signal voltage (note 3)	$V_{ID}$	DC - DDRT	0.36		$V_{DD} + 0.6$	V
		AC - DDRT	0.7		$V_{DD} + 0.6$	V
Output differential cross-voltage (note 4)	$V_{OX}$		$V_{DD}/2 - 0.15$		$V_{DD}/2 + 0.15$	V
Input differential cross-voltage (note 4)	$V_{IX}$		$V_{DD}/2 - 0.2$	$V_{DD}/2$	$V_{DD}/2 + 0.2$	V
High level output current	$I_{OH}$				-30	mA
Low level output current	$I_{OL}$				-30	mA
Operating free-air temperature	$T_A$		0		85	$^\circ\text{C}$

### Notes:

1. Unused inputs must be held high or low to prevent them from floating.
2. DC input signal voltage specifies the allowable DC execution of differential input.
3. Differential inputs signal voltages specifies the differential voltage [VTR-VCP] required for switching, where VT is the true input level and VCP is the complementary input level.
4. Differential cross-point voltage is expected to track variations of  $V_{DD}$  and is the voltage at which the differential signal must be crossing.

## Timing Requirements

$T_A = 0 - 70^\circ\text{C}$ ; Supply Voltage  $A_{VDD}$ ,  $V_{DD} = 2.5\text{ V} \pm 0.2\text{V}$  (unless otherwise stated)

PARAMETER	SYMBOL	CONDITIONS	MIN	MAX	UNITS
Max clock frequency	$\text{freq}_{\text{op}}$	$2.5\text{V} \pm 0.2\text{V}$ @ $25^\circ\text{C}$	45	600	MHz
Application Frequency Range	$\text{freq}_{\text{App}}$	$2.5\text{V} \pm 0.2\text{V}$ @ $25^\circ\text{C}$	95	233	MHz
Input clock duty cycle	$d_{\text{tin}}$		40	60	%
CLK stabilization	$T_{\text{STAB}}$			15	$\mu\text{s}$

## Switching Characteristics<sup>3</sup>

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Low-to high level propagation delay time	$t_{\text{PLH}}^1$	BUF_IN to any output		3.5		ns
High-to low level propagation delay time	$t_{\text{PLL}}^1$	BUF_IN to any output		3.5		ns
Period jitter	$T_{\text{jit(per)}}$	100MHz to 200MHz	-30		30	ps
Half-period jitter	$t(\text{jit\_hper})$	100MHz to 200MHz	-100		100	ps
Input clock slew rate	$t_{\text{sl(i)}}$		1		4	V/ns
Output clock slew rate	$t_{\text{sl(o)}}$		1		2	V/ns
Cycle to Cycle Jitter <sup>1</sup>	$T_{\text{cyc}} - T_{\text{cyc}}$	100MHz to 200MHz	-50		50	ps
Static Phase Offset	$t_{\text{(static phase offset)}}^4$		-50	0	50	ps
Output to Output Skew	$T_{\text{skew}}$				40	ps

### Notes:

1. Refers to transition on noninverting output in PLL bypass mode.
2. While the pulse skew is almost constant over frequency, the duty cycle error increases at higher frequencies. This is due to the formula: duty cycle =  $t_{\text{WH}}/t_{\text{C}}$ , where the cycle ( $t_{\text{C}}$ ) decreases as the frequency goes up.
3. Switching characteristics guaranteed for application frequency range.
4. Static phase offset shifted by design.

## General I<sup>2</sup>C serial interface information for the ICS9P935

### How to Write:

- Controller (host) sends a start bit.
- Controller (host) sends the write address D4<sub>(H)</sub>
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) sends the data byte count = X
- ICS clock will **acknowledge**
- Controller (host) starts sending **Byte N through Byte N + X - 1**  
(see Note 2)
- ICS clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

### How to Read:

- Controller (host) will send start bit.
- Controller (host) sends the write address D4<sub>(H)</sub>
- ICS clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- ICS clock will **acknowledge**
- Controller (host) will send a separate start bit.
- Controller (host) sends the read address D5<sub>(H)</sub>
- ICS clock will **acknowledge**
- ICS clock will send the data byte count = X
- ICS clock sends **Byte N + X - 1**
- ICS clock sends **Byte 0 through byte X (if X<sub>(H)</sub> was written to byte 8).**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

Index Block Write Operation		
Controller (Host)		ICS (Slave/Receiver)
T	starT bit	
Slave Address D4 <sub>(H)</sub>		
WR	WRite	
		ACK
Beginning Byte = N		
		ACK
Data Byte Count = X		
		ACK
Beginning Byte N		X Byte
○		
○		
○		
Byte N + X - 1		
		ACK
P	stoP bit	

Index Block Read Operation		
Controller (Host)		ICS (Slave/Receiver)
T	starT bit	
Slave Address D4 <sub>(H)</sub>		
WR	WRite	
		ACK
Beginning Byte = N		
		ACK
RT	Repeat starT	
Slave Address D5 <sub>(H)</sub>		
RD	ReaD	
		ACK
		Data Byte Count = X
ACK		
		Beginning Byte N
ACK		X Byte
○		
○		
○		
Byte N + X - 1		
N	Not acknowledge	
P	stoP bit	

### Notes:

1. The IDT clock generator is a slave/receiver, I<sup>2</sup>C component. It can read back the data stored in the latches for verification.  
**Read-Back will support SMBus block read protocol.**
2. The data transfer rate supported by this clock generator is 100K bits/sec or less (standard mode)
3. The input is operating at 3.3V logic levels.
4. The data byte format is 8 bit bytes.
5. To simplify the clock generator I<sup>2</sup>C interface, the protocol is set to use only "**Block-Writes**" from the controller. The bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. The Command code and Byte count shown above must be sent, The data is loaded until a Stop sequence is issued.
6. At power-on, all registers are set to a default condition, as shown.

I<sup>2</sup>C Table: Output Control Register

Byte 6	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	Freq Detect	Low Frequency Detect PLL OFF Control	RW	OFF	ON	1
Bit 6	-	FB_IN/OUT	FB_OUT Control	RW	Disable	Enable	1
Bit 5	-	DDR_T5/C5	Output Control	RW	Disable	Enable	1
Bit 4	-	DDR_T4/C4	Output Control	RW	Disable	Enable	1
Bit 3	-	DDR_T3/C3	Output Control	RW	Disable	Enable	1
Bit 2	-	DDR_T2/C2	Output Control	RW	Disable	Enable	1
Bit 1	-	DDR_T1/C1	Output Control	RW	Disable	Enable	1
Bit 0	-	DDR_T0/C0	Output Control	RW	Disable	Enable	1

I<sup>2</sup>C Table: Group Skew Control Register

Byte 8	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	DDR Skw3	CLKIN to DDR Skew Control	RW	See Table 1: 7-Step Skew Programming Table		0
Bit 6	-	DDR Skw2		RW			0
Bit 5	-	DDR Skw1		RW			0
Bit 4	-	DDR Skw0		RW			0
Bit 3	-	DDR Skw3	CLKIN to DDR Skew Control	RW	See Table 2: 7-Step Skew Programming Table		0
Bit 2	-	DDR Skw2		RW			0
Bit 1	-	DDR Skw1		RW			0
Bit 0	-	DDR Skw0		RW			0

I<sup>2</sup>C Table: Revision ID and Vendor ID Register

Byte 10	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	Revision_ID bit 3	Rev ID	RW	-	-	X
Bit 6	-	Revision_ID bit 2		RW	-	-	X
Bit 5	-	Revision_ID bit 1		RW	-	-	X
Bit 4	-	Revision_ID bit 0		RW	-	-	X
Bit 3	-	Vendor_ID bit3	Vendor ID	RW	-	-	0
Bit 2	-	Vendor_ID bit2		RW	-	-	0
Bit 1	-	Vendor_ID bit1		RW	-	-	0
Bit 0	-	Vendor_ID bit0		RW	-	-	1

I<sup>2</sup>C Table: Byte Count Register

Byte 15	Pin #	Name	Control Function	Type	0	1	PWD
Bit 7	-	BC7	Byte Count Programming b(7:0)	RW	Writing to this register will configure how many bytes will be read back, default is 0F = 15 bytes		0
Bit 6	-	BC6		RW			0
Bit 5	-	BC5		RW			0
Bit 4	-	BC4		RW			0
Bit 3	-	BC3		RW			1
Bit 2	-	BC2		RW			1
Bit 1	-	BC1		RW			1
Bit 0	-	BC0		RW			1

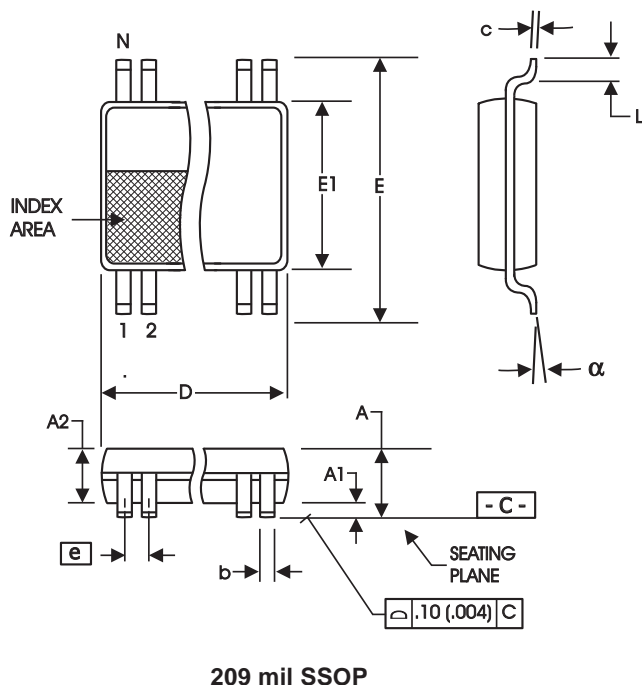
I<sup>2</sup>C Table: All other I<sup>2</sup>C Registers are Reserved

Table 1: 7-Steps Skew Programming Table

7 Step	11	10	01	00	LSB
11	600 ps	500 ps	400 ps	300 ps	
10	N/A	N/A	N/A	200 ps	
01	N/A	N/A	N/A	100 ps	
00	N/A	N/A	N/A	0.0 ps	
MSB					

Table 2: 7-Steps Skew Programming Table

7 Step	11	10	01	00	LSB
11	-600 ps	-500 ps	-400 ps	-300 ps	
10	N/A	N/A	N/A	-200 ps	
01	N/A	N/A	N/A	-100 ps	
00	N/A	N/A	N/A	0.0 ps	
MSB					



SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	2.00	--	.079
A1	0.05	--	.002	--
A2	1.65	1.85	.065	.073
b	0.22	0.38	.009	.015
c	0.09	0.25	.0035	.010
D	SEE VARIATIONS		SEE VARIATIONS	
E	7.40	8.20	.291	.323
E1	5.00	5.60	.197	.220
e	0.65 BASIC		0.0256 BASIC	
L	0.55	0.95	.022	.037
N	SEE VARIATIONS		SEE VARIATIONS	
$\alpha$	0°	8°	0°	8°

VARIATIONS

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.90	10.50	.390	.413

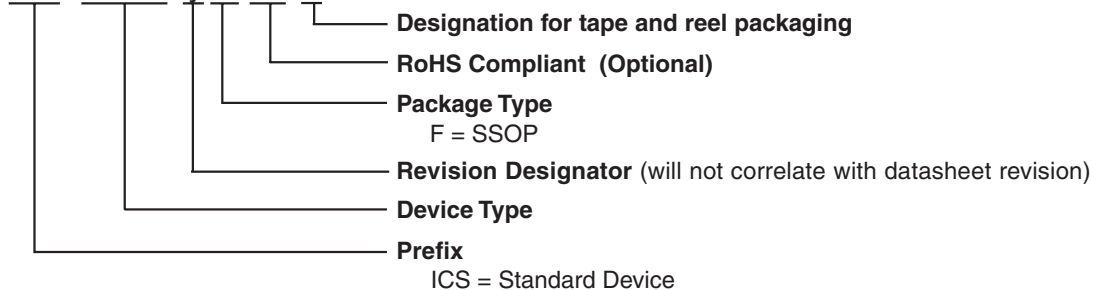
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10-0033

## Ordering Information

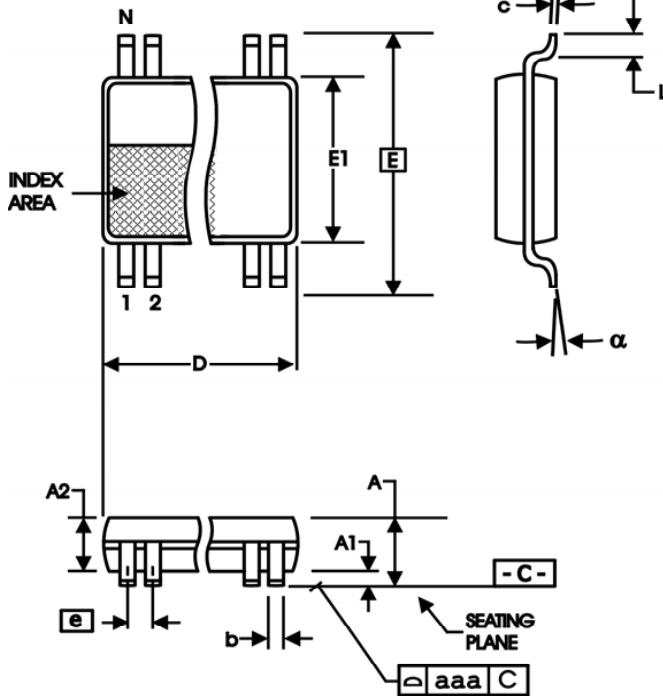
ICS9P935yFLF-T

Example:

ICS XXXX y F LF-T



**ICS9P935**  
**DDR I/DDR II Phase Lock Loop Zero Delay Buffer**



**4.40 mm. Body, 0.65 mm. Pitch TSSOP**  
**(173 mil) (25.6 mil)**

SYMBOL	In Millimeters COMMON DIMENSIONS		In Inches COMMON DIMENSIONS	
	MIN	MAX	MIN	MAX
A	--	1.20	--	.047
A1	0.05	0.15	.002	.006
A2	0.80	1.05	.032	.041
b	0.19	0.30	.007	.012
c	0.09	0.20	.0035	.008
D	SEE VARIATIONS		SEE VARIATIONS	
E	6.40 BASIC		0.252 BASIC	
E1	4.30	4.50	.169	.177
e	0.65 BASIC		0.0256 BASIC	
L	0.45	0.75	.018	.030
N	SEE VARIATIONS		SEE VARIATIONS	
alpha	0°	8°	0°	8°
aaa	--	0.10	--	.004

**VARIATIONS**

N	D mm.		D (inch)	
	MIN	MAX	MIN	MAX
28	9.60	9.80	.378	.386

Reference Doc.: JEDEC Publication 95, MO-153

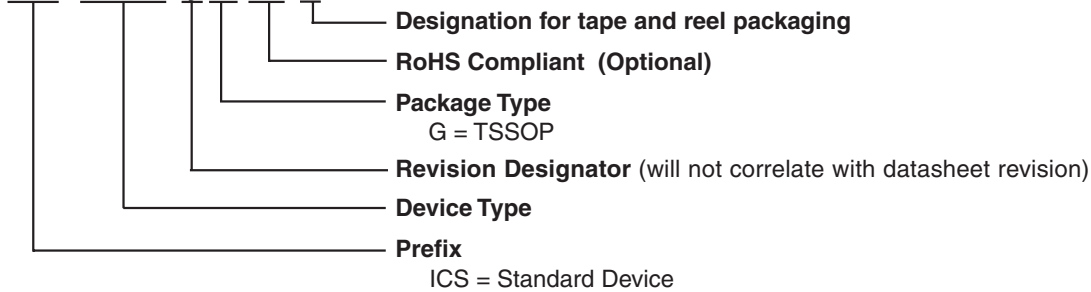
10-0035

**Ordering Information**

**ICS9P935yGLF-T**

Example:

**ICS XXXX y G LF-T**



## Revision History

Rev.	Issue Date	Description	Page #
A	2/8/2007	Final Release.	-
B	6/4/2007	Fixed various typos.	-
C	6/14/2007	Added TSSOP Ordering Information.	12
D	6/20/2007	1. Updated Output Features: Max Frequency Supported. 2. Updated DDRI/DDRII Max Clock Frequency.	1 5, 8
E	8/16/2007	1. Updated Supply Voltage. 2. Updated Input High/Low Current Max.	3
F	9/5/2007	Updated Electrical Specifications.	3-5
G	11/19/2007	Updated Serial Interface Information.	9
H	12/1/2008	Updated Pin Description.	2

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